

Serial No. 09/653,295

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Patent Application

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Case: **3-6-16**

Serial No.: **09/653,295**

Filing Date: **August 31, 2000**

Examiner: **Nguyen**

Group Art Unit: **2811**

Title: **Stacked Structure For Parallel Capacitors And Method Of Fabrication**

**ASSISTANT COMMISSIONER FOR PATENTS
WASHINGTON, D. C. 20231-**

SIR:

Amendment Under 37 C.F.R. §1.111

In response to the office action of January 28, 2002, please amend the above-identified application as follows:

IN THE SPECIFICATION

(1) Please replace the sentence at page 1, line 22 with the following rewritten

Q1 sentence: In particular, further reduction in area requirements for capacitors will enable further improvement in the level of integration for both digital and analog circuitry.

(2) Please replace the sentence at page 1, line 21 with the following rewritten

Q2 sentence: Prior efforts to increase capacitance without increasing area consumed over a semiconductor region were effected by forming multiple capacitors on separate metal levels and connecting these in parallel.